

Electronic Patent Application Fee Transmittal

Application Number:	10597136
Filing Date:	12-Jul-2006
Title of Invention:	SEMICONDUCTOR DEVICE MODULE STRUCTURE
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Filer:	David Spaw/Paula Almasy
Attorney Docket Number:	SHM-16693

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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
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Total in USD (\$)				1810